



SUSS MICROTEC – HALF YEAR FIGURES 2016



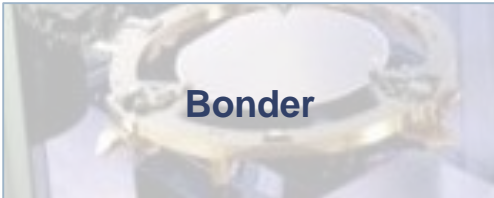
August 5, 2016

- + Launch of new Mask Aligner MA/BA Gen4 series**
- + Extension of Technology Portfolio by Laser Surface Imaging**
- + Introduction of eco-friendly LED-Technology for Mask Aligner**
- + Q2 Order entry at upper end of guidance**
- + Positive Free cash Flow in Q2 2016**
- + Market environment remains challenging with customers ramping new capacity ordered year end 2015 and investments in new FOWLP lines are pushing out**
- + Suss MicroTec received Outstanding Supplier Award from leading Chinese OSAT in Advanced Packaging space**

KEY FINANCIALS

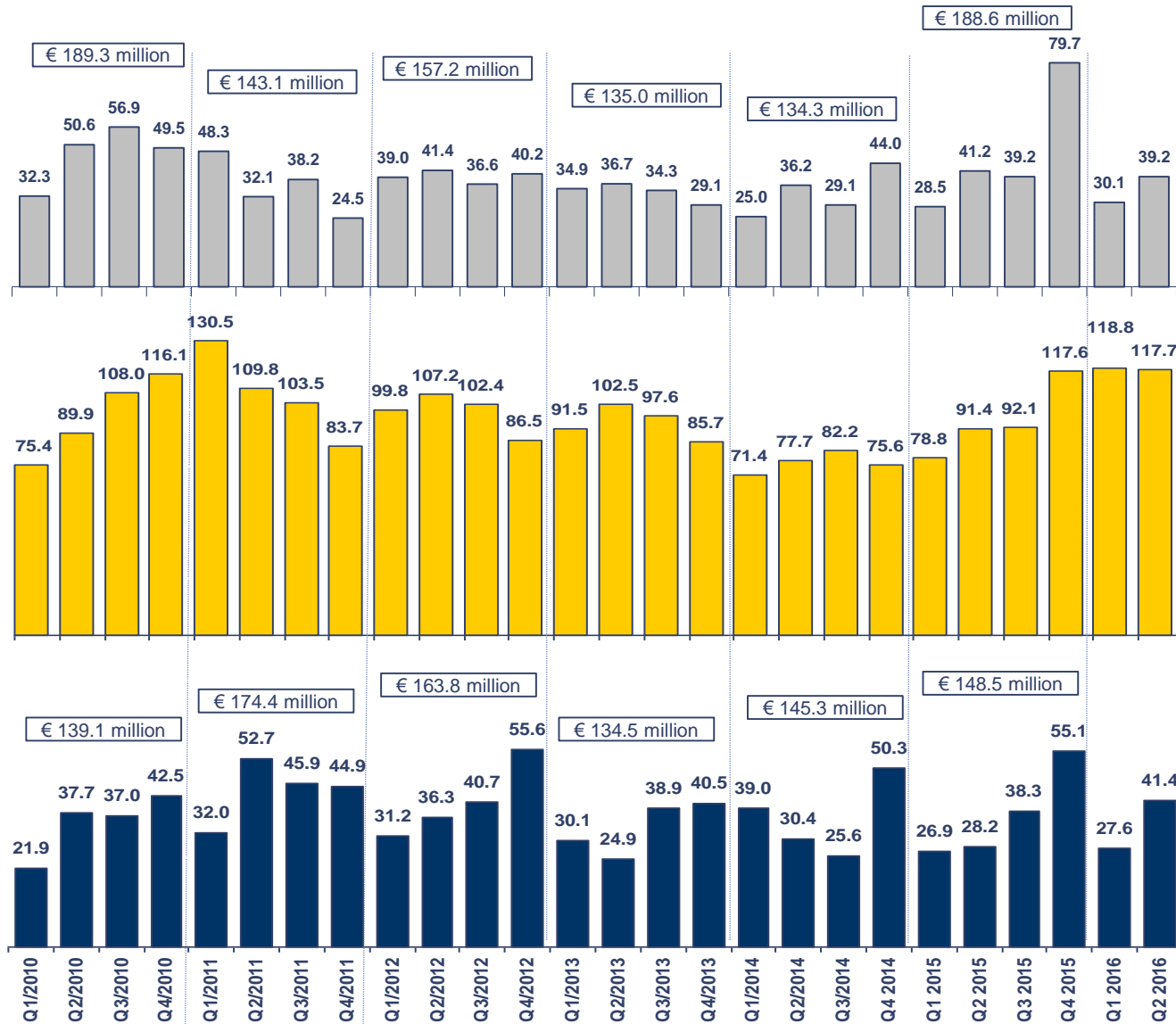
in € million	Q2 2016	Q2 2015	in %
Order Intake	39.2	41.2	-4.9%
Order Backlog 6/30	--	--	--
Revenue	41.4	28.1	47.3%
EBIT	0.9	-1.7	--
<i>EBIT in % of Sales</i>	<i>2.2%</i>	<i>-6.0%</i>	<i>--</i>
Earnings after tax	-0.6	-2.1	-71.4%
EPS in €	-0.03	-0.11	-72.7%
Free Cash Flow	0.9	-7.7	--
Net Cash	--	--	--
Employees 6/30	--	--	--

<i>H1 2016</i>	<i>H1 2015</i>
69.3	69.7
117.7	91.4
69.0	55.1
-1.0	-3.9
-1.4%	-7.1%
-3.1	-4.6
-0.16	-0.24
-12.0	-13.2
28.1	25.6
717	683

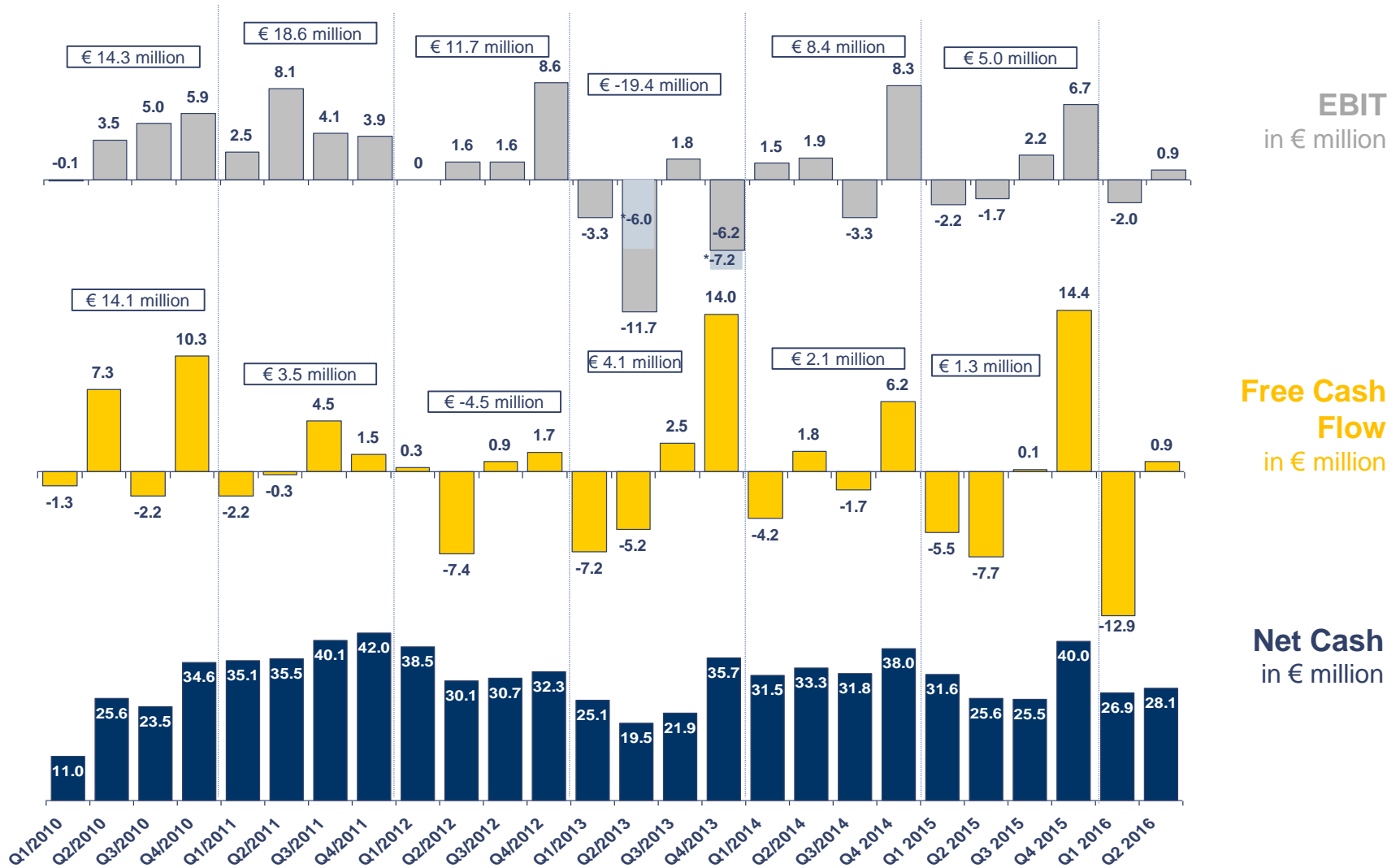
Divisions						
						
Photomask Cleaning Equipment		Laser Processing Equipment	Exposure Systems	Coaters and Developers	Wafer Bonding Equipment	
FY 2015	Order Entry: 21.5 € million Sales: 23.5 € million EBIT: 2.3 € million	Order Entry: 149.6 € million Sales: 106.3 € million EBIT: 9.7 € million			Order Entry: 10.5 € million Sales: 11.4 € million EBIT: -4.0 € million	
H1 2016	Order Entry: 11.8 € million Sales: 4.6 € million EBIT: -0.8 € million	Order Entry: 47.8 € million Sales: 56.1 € million EBIT : 3.6 € million			Order Entry: 4.2 € million Sales: 4.0 € million EBIT : -2.1 € million	
SUSS MicroTec Group* H1 2016		Order Entry: 69.3 € million Sales: 69.0 € million			EBIT: -1.0 € million EBIT margin: -1.4%	

* Including Others

LONG TERM BUSINESS DEVELOPMENT BY QUARTER



EBIT, FREE CASH FLOW AND NET CASH DEVELOPMENT



* one-off effect from restructuring the product line permanent bonding

Market Outlook

- + Market environment remains challenging in H2 2016 as customers are ramping capacity ordered year end 2015
- + Outlook of SUSS MicroTec and peer group companies remains cautiously optimistic for H2 2016 as further capacity expansions for Advanced Packaging are expected, however timing of new FOWLP production line investments appears to be pushing out
- + Expectations for the overall semiconductor equipment market is expected to be flat or slightly down yoy in 2016
- + Market forecasts show a return to the growth path in WLP and assembly in 2017

SUSS MicroTec Outlook

- + FY 2016: Sales 170 - 180 € million
 EBIT 9 - 13 € million
- + H2 2016: Order Intake 80 - 90 € million
- + FY 2017: Sales around 160 € million

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Thank you!

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